

4.0x4.0mm RIGHT ANGLE SURFACE MOUNT **LED LAMP**

Part Number: KA-4040SESK

Super Bright Orange

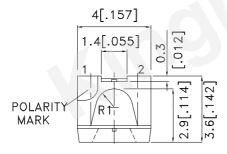
Features

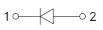
- · Single color.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Ideal for backlighting.
- Package: 500pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

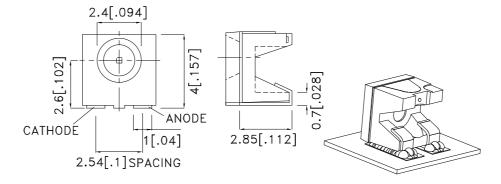
Description

The Super Bright Orange device is made with AlGaInP (on GaAs substrate) light emitting diode chip.

Package Dimensions







- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

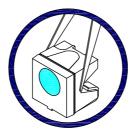


SPEC NO: DSAK9798 **REV NO: V.5A** DATE: MAR/06/2013 PAGE: 1 OF 6 APPROVED: WYNEC DRAWN: Y.Liu **CHECKED: Allen Liu** ERP: 1201006829

Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.





3. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

Detailed application notes are listed on our website. http://www.kingbright.com/application notes

 SPEC NO: DSAK9798
 REV NO: V.5A
 DATE: MAR/06/2013
 PAGE: 2 OF 6

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: Y.Liu
 ERP: 1201006829

Selection Guide

Part No.	Dice Lens Type		Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KA-4040SESK	Super Bright Orange (AlGalnP)	Water Clear	200	450	- 120°
NA-40403E3N		vvalei Ciedi	*80	*220	

- Notes: 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity/ luminous Flux: +/-15%.

 * Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Orange	610		nm	IF=20mA
λD [1]	Dominant Wavelength	Super Bright Orange	601		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Orange	29		nm	IF=20mA
С	Capacitance	Super Bright Orange	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Super Bright Orange	2.1	2.5	V	IF=20mA
lr	Reverse Current	Super Bright Orange		10	uA	VR=5V

Notes:

- 1.Wavelength: +/-1nm.
 2. Forward Voltage: +/-0.1V.
 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

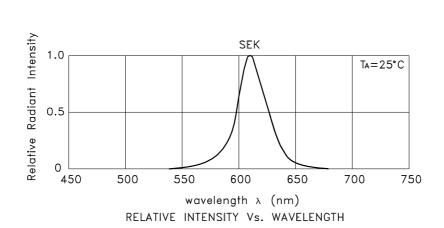
Absolute Maximum Ratings at TA=25°C

Super Bright Orange							
75	mW						
30	mA						
195	mA						
5	V						
-40°C To +85°C							
-40°C To +85°C							
	75 30 195 5 -40°C To +85°C						

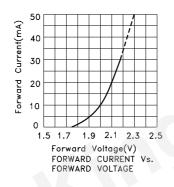
Note:

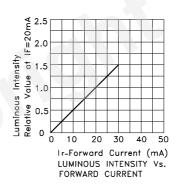
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

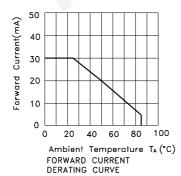
SPEC NO: DSAK9798 **REV NO: V.5A** DATE: MAR/06/2013 PAGE: 3 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.Liu ERP: 1201006829

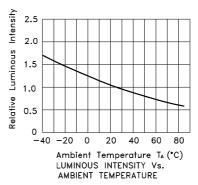


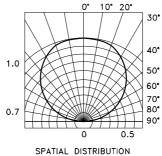
Super Bright Orange KA-4040SESK









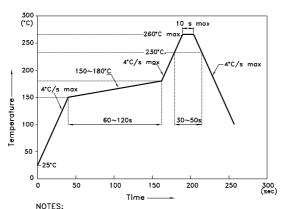


SPEC NO: DSAK9798 REV NO: V.5A DATE: MAR/06/2013 PAGE: 4 OF 6
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.Liu ERP: 1201006829

KA-4040SESK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



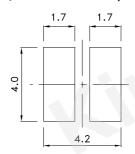
NOTES:

1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

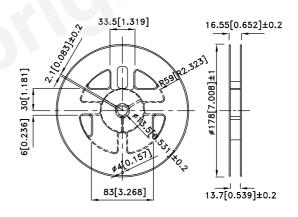
3.Number of reflow process shall be 2 times or less.

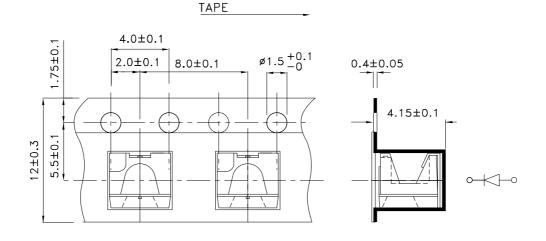
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



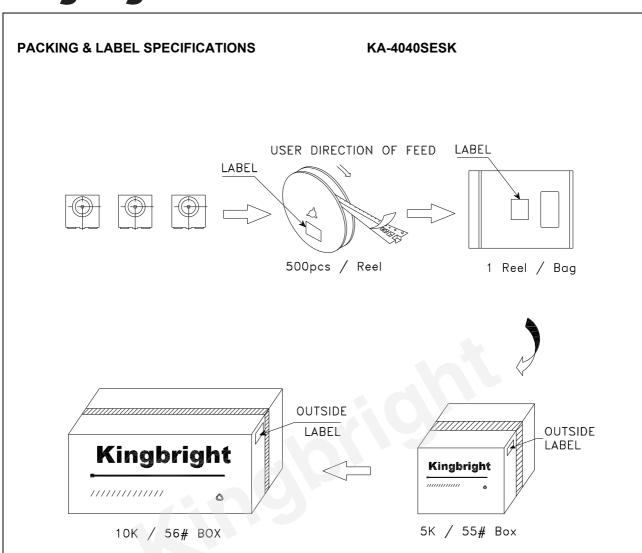
Tape Dimensions (Units: mm)

Reel Dimension





SPEC NO: DSAK9798 **REV NO: V.5A DATE: MAR/06/2013** PAGE: 5 OF 6 **APPROVED: WYNEC CHECKED: Allen Liu** DRAWN: Y.Liu ERP: 1201006829





SPEC NO: DSAK9798 APPROVED: WYNEC REV NO: V.5A CHECKED: Allen Liu DATE: MAR/06/2013 DRAWN: Y.Liu PAGE: 6 OF 6 ERP: 1201006829